

Allwinner A33 Datasheet

Quad Core Tablet Processor

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1 OVERVIEW

The Allwinner A33 is a remarkably power-efficient quad-core tablet processor based on ARM Cortex™-A7 CPU along with Mali400MP2 GPU architecture. It is also highly competitive in terms of system cost thanks to its high system integration and is capable of delivering excellent user experience while maintaining ultra low power consumption.

Main features of A33 include:

- CPU architecture: A33 processor packs the most power efficient quad-core Cortex™-A7 CPU architecture deliver outstanding system performance and impressive battery life experience;
- Graphic: A33 adopts the extensively implemented and technically mature Mali400MP2 GPU to provide end users with superior experience in web browsing, video playback and games, etc.; OpenGL ES 2.0 and OpenVG 1.1 standards are supported;
- Video Engine: A33 supports high-definition 1080P video processing and various mainstream video standards such as H.264, VP8, MPEG 1/2/4, JPEG/MJPEG, etc.;
- Display: A33 supports CPU/RGB/LVDS LCD interface up to 1280x800 resolution. Four-lane MIPI DSI (Display Serial Interface) is integrated as well, supporting MIPI DSI V1.01 and MIPI D-PHY V1.00;
- Image: A33 supports a parallel CMOS sensor interface up to 5M resolution

Thanks to its advanced system design and outstanding software optimization, the A33 is capable of providing top-notch system performance with long-lasting battery life experience: in addition to its powerful yet energy-efficient Cortex™-A7 CPU architecture, advanced fabrication process, video acceleration hardware, DVFS technology support and high system integration, A33 also features a unique Talking Standby Mode where the processor can be inactive during voice calls to provide end users with ultra-long battery life experience. Additionally, Allwinner A33 features high system integration with a wide range of integrated I/Os like 4-lane MIPI DSI, LVDS, USB Dual Role Device, USB Host, SD/MMC, I2S /PCM, SPI, thus significantly reducing system components required in design to simplify product design and reduce total system costs.

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FEATURES

2.1. CPU Architecture

The A33 platform is based on quad-core Cortex™-A7 CPU architecture.

- ARMv7 ISA standard instruction set plus Thumb-2 and Jazeller RCT
- NEON with SIMD and VFPv4 support
- Support hardware virtualization
- Support LPAE
- Support 4GB address space
- Support 256KB L1 cache and shared 512KB L2 cache
- Support DVFS with independent power domain

2.2. GPU

- Mali400MP2 GPU
- Support OpenGL ES 2.0 / OpenVG 1.1 standard

2.3. Memory Subsystem

This section consists of:

- Boot ROM
- SDRAM
- NAND Flash
- SD/MMC interface

Boot ROM

- Support system boot from Raw NAND, eMMC NAND, SPI NOR Flash, and SD/TF card
- Support system code download through USB DRD(Dual Role Device)

SDRAM

- Support 2GB address space
- Support 16-bit bus width
- Compatible with JEDEC standard DDR3 /DDR3L SDRAM
- Support Memory Dynamic Frequency Scale
- Support two ranks
- Support 16 address signal lines and 3 bank signal lines

NAND Flash

- Comply to ONFI 2.3 and Toggle 1.0
- Support 64-bit ECC per 512 bytes or 1024 bytes
- Support 8-bit Raw NAND flash controller sharing pin with eMMC
- Support 2 CE and 2 RB signals
- Support SLC/MLC/TLC NAND and EF-NAND

SD/eMMC Interface

- Comply to eMMC standard specification V4.41, SD physical layer specification V2.0, SDIO card specification V2.0
- Support 4/8-bit bus width
- Support HS/DS bus mode
- Support 3 SD/eMMC controllers
- Support SDIO interrupt detection
- Support CRC generation and error detection
- Support block size from 1 to 65535 bytes

2.4. System Peripheral

This section includes:

- Timer
- High Speed Timer
- RTC
- GIC
- DMA
- CCU
- PWM

Timer

- Support two timers: clock source can be switched over 24MHz and 32768Hz
- Support two 33-bit AVS counters
- Support one 64-bit system counter from 24MHz
- Support a watchdog to generate reset signal or interrupts

High Speed Timer

- Clock source is fixed to AHB, and the pre-scale ranges from 1 to 16
- Support a 56-bit counter

RTC

- Support full clock features: second/minute/hour/day/month/year
- Support a 32768Hz clock fanout

GIC

- Support 16 SGIs, 16 PPIs and 128 SPIs
- Support ARM architecture security extensions
- Support ARM architecture virtualization extensions
- Support single processor and multiple processors environment

DMA

- 8-channel DMA
- Support data width of 8/16/32 bits
- Support linear and IO address modes
- Support data transfer types with memory-to-memory, memory-to-peripheral, peripheral-to-memory

CCU

- 11 PLLs
- Support a 24MHz oscillator, a 32768Hz oscillator and an on-chip RC oscillator
- Support clock gating control for individual components
- Clock generation, clock division, clock output

PWM

- Support two PWM outputs
- Support cycle mode and pulse mode
- Support prescale from 1 to 16

2.5. Security System

SS

- Support Symmetrical Algorithm: AES, DES, 3DES
- Support Hash Algorithm: SHA-1, MD5
- Support 160-bits hardware PRNG with 192-bits seed
- Support ECB, CBC, CTR modes for DES/3DES
- Support ECB, CBC, CTR, CTS modes for AES
- Support 128-bits, 192-bits and 256-bits key size for AES
- 32-words RX FIFO and 32-words TX FIFO for high speed application
- CPU mode and DMA mode operation

2.6. Display Subsystem

This section includes:

- Display engine
- Video output

Display Engine

- Four movable layers, each layer size up to 2048x2048 pixels
- Ultra-Scaling engine
 - Support four-tap scale filter in both horizontal and vertical
 - Support input size up to 1920x1920 resolution and output size up to 1280x1280 resolution
- Support multiple image input formats: mono 1/2/4/8bpp, palette 1/2/4/8bpp, 6/24/32bpp color, YUV444/420/422/411
- Support alpha blending / color key / gamma
- Support output color correction: luminance / hue / saturation, etc
- Support Saturation Enhancement and Dynamic Range Control
- Support realtime write back function

Video Output

- Support CPU / Sync RGB / LVDS LCD interface up to 1280x800 resolution
- Support 1/2/4-lane MIPI DSI interface up to 1280x800 resolution
 - Support MIPI DSI V1.01 and MIPI D-PHY V1.00
 - Support command mode and video mode (non-burst mode with sync pulses, non-burst mode with sync event and burst mode)
- Support RGB666 dither function

2.7. Video Engine

Video Decoding

- Support video playback up to 1920x1080@60fps
- Support multi-format video playback, including MPEG1/2, MPEG4 SP/ASP GMC, WMV9/VC1, H.263 including Sorenson Spark, H.264 BP/MP/HP, VP8, WMV9/VC-1, JPEG/MJPEG, etc

Video Encoding

- Support H.264 HP video encoding up to 1920x1080@60fps
- JPEG baseline: picture size up to 4080x4080
- Support Alpha blending
- Support thumb generation
- Support 4x2 scaling ratio: from 1/16 to 64 arbitrary non-integer ratio

2.8. Video Input

CSI

- Support parallel camera sensor
- Support 8-bit CCIR601/656 interface
- Support up to 5M pixel camera sensor
- Support dual outputs for display and encoding

2.9. Audio Subsystem

Audio Codec

- Support stereo audio DAC
 - Up to 100dB SNR
 - 8KHz ~ 192KHz DAC sample rate
- Support stereo audio ADC
 - Up to 92dB SNR
 - 8KHz ~ 48KHz ADC sample rate
- Support four analog audio inputs
 - Two microphone differential inputs for main mic and headphone mic
 - One differential phone input for modem
 - One stereo line-in input for FM
- Support two analog audio outputs
 - One stereo or differential capless headphone output
 - One differential earpiece output
- Support Talking Standby Mode, where the application processor remains inactive during voice call application for power saving, support noise reduction
- Support Dynamic Range Controller(DRC) adjusting the DAC playback output
- Support Automatic Gain Control(AGC) adjusting the ADC recording output
- Two PCM interface connected with BB and BT

2.10 External Peripherals

This section includes:

- USB 2.0 DRD
- USB HOST
- LRADC
- Digital Audio Interface
- UART
- SPI
- Open-drain TWI
- RSB™

USB 2.0 DRD

- Support High-Speed (HS, 480Mbps), Full-Speed (FS, 12Mbps), and Low-Speed (LS, 1.5Mbps) in Host mode
- Support High-Speed (HS, 480Mbps) and Full-Speed (FS, 12Mbps) in Device mode
- Support up to five configurable endpoints for bulk, isochronous, control and interrupt
- Support the embedded DMA

USB Host

- EHCI/OHCI-compliant host
- USB2.0 PHY and HSIC
- Support High-Speed(HS,480Mbps),Full-Speed(FS,12Mbps), and Low-Speed(LS,1.5Mbps)Device
- An internal DMA Controller for data transfer with memory

KEYADC

- 6-bit resolution
- Support hold key and continuous key
- Support single key,normal key and continuous key

Digital Audio Interface

- Two I2S/PCM compliant digital audio interfaces for modem and bluetooth
- I2S or PCM configured by software
- Support 3 I2S Data formats:Standard I2S,Left Justified and Right Justified
- I2S supports 2 channels output and 2 channels input
- PCM supports linear sample(8-bit or 16-bit), 8-bit u-law and A-law companded sample
- Sample rate from 8KHz to 192KHz
- Support 16,20,24bits audio data resolutions
- One 128x24-bits FIFO for data transmit,one 64x24-bits FIFO for data receive

UART

- Support six UART controllers
- FIFO size up to 64 bytes
- Support speed up to 3MHz
- Compliant with industry-standard 16550 UARTs
- Support Infrared Data Association(IrDA)1.0 SIR

SPI

- Two SPI controllers
- Full-duplex synchronous serial interface
- Master/Slave configurable
- Polarity and phase of the Chip Select and SPI Clock are configurable
- Two 64-bytes FIFO for SPI-TX and SPI-RX operation
- DMA-based or interrupt-based operation

TWI

- Up to four TWI(Two Wire Interface) controllers
- Support one dedicated TWI controller for CSI
- Support speed up to 400Kbps
- Master/Slave configurable
- Allows 10-bits addressing transactions

RSB™ (Reduced Serial Bus)

- Support transfer speed up to 20MHz
- Support Push-Pull bus
- Support Host mode
- Support multiple devices
- Programmable output delay of CD signal
- Parity check for address and data transmission

2.11. Power Management

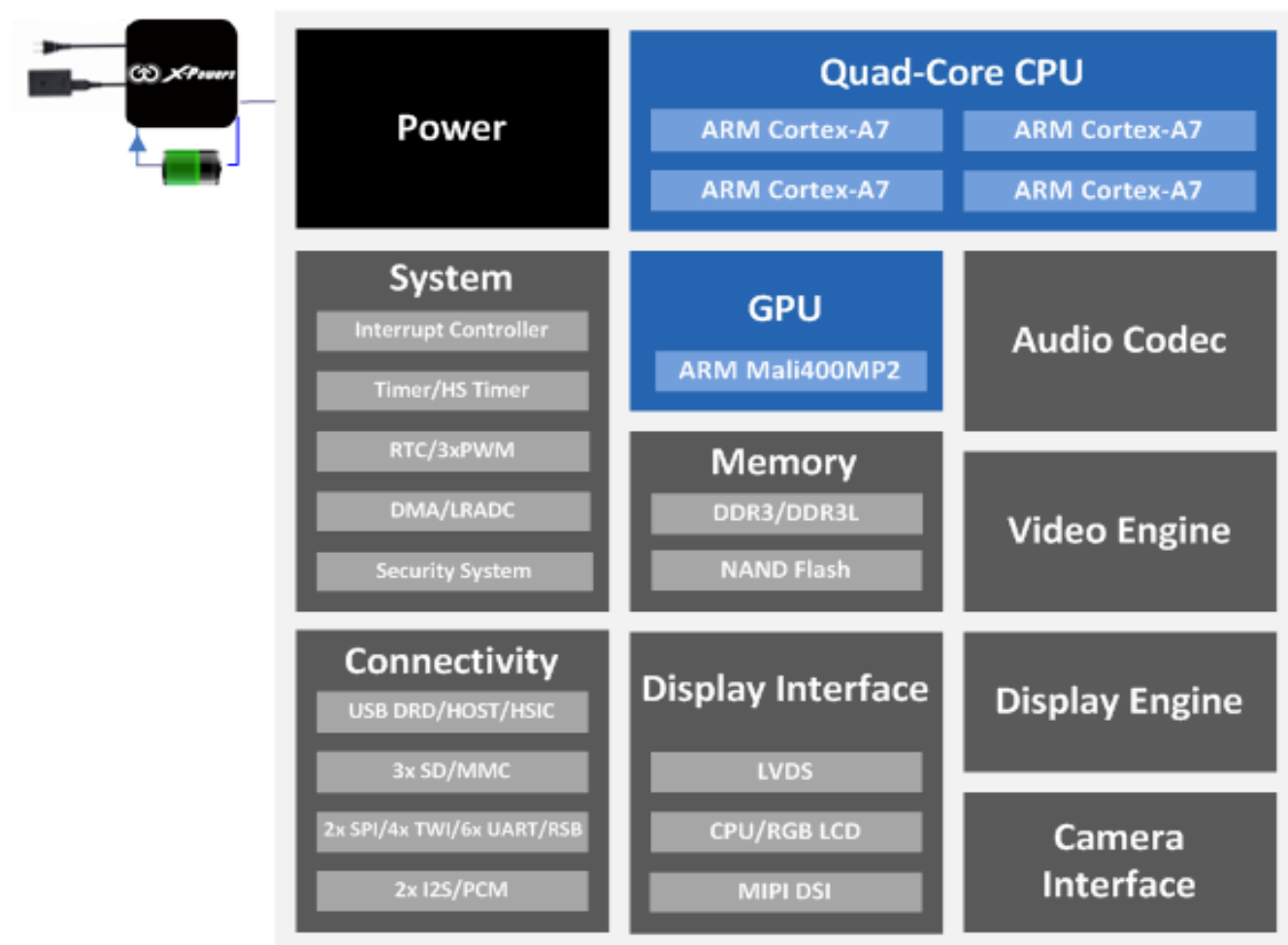
- Support DVFS for CPU frequency and voltage adjustment
- Support super standby mode for energy efficiency
- Support talking standby mode for energy efficiency during voice call application

2.12. Package

- TFBGA 282 balls, 0.8mm ball pitch, 14 x 14 x 1.4-mm

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BLOCK DIAGRAM



A33 Block Diagram

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PIN DESCRIPTION

4.1. PIN CHARACTERISTICS

Following table describes the A33 pin characteristics from seven aspects: **BALL#**, **Pin Name**, **Default Function**¹, **Type**², **Reset State**³, **Default Pull Up/Down**⁴, and **Buffer Strength**⁵.

BALL#	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
SDRAM						
M1	DQ0	DRAM	I/O	Z	-	-
M2	DQ1	DRAM	I/O	Z	-	-
L1	DQ2	DRAM	I/O	Z	-	-
L2	DQ3	DRAM	I/O	Z	-	-
J1	DQ4	DRAM	I/O	Z	-	-
J2	DQ5	DRAM	I/O	Z	-	-
H1	DQ6	DRAM	I/O	Z	-	-
H2	DQ7	DRAM	I/O	Z	-	-
U3	DQ8	DRAM	I/O	Z	-	-
U1	DQ9	DRAM	I/O	Z	-	-
U2	DQ10	DRAM	I/O	Z	-	-
T2	DQ11	DRAM	I/O	Z	-	-
R2	DQ12	DRAM	I/O	Z	-	-
P1	DQ13	DRAM	I/O	Z	-	-
P2	DQ14	DRAM	I/O	Z	-	-
N1	DQ15	DRAM	I/O	Z	-	-
M4	DVREF	DRAM	P	-	-	-
R1	DQS1	DRAM	I/O	Z	-	-
T1	DQS1B	DRAM	I/O	Z	-	-
T3	DQM1	DRAM	O	Z	-	-
K2	DQS0	DRAM	I/O	Z	-	-
K1	DQS0B	DRAM	I/O	Z	-	-
N2	DQM0	DRAM	O	Z	-	-

Note:

- Default function** defines the default function of each pin, especially for pins with multiplexing functions;
- There are five **pin types** here: O for output, I for input, I/O for input/output, A for analog, OD for Open-Drain, P for power and G for ground;
- Reset state** defines the state of the terminal at reset: Z for high-impedance, F for Multiplexing Function Pin;
- Default Pull up/down** defines the presence of an internal pull up or pull down resistor. Unless otherwise specified, the pin is default to be floating, and can be configured as pull up or pull down;
- Buffer strength** defines the driver strength of the associated output buffer. It is tested in the condition that VCC=3.0V, strength=MAX;

BALL#	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
G2	DCKB	DRAM	O	Z	-	-
G1	DCK	DRAM	O	Z	-	-
J4	DCKE	DRAM	O	Z	-	-
N7	DCKE1	DRAM	O	Z	-	-
E4	DA0	DRAM	O	Z	-	-
D1	DA1	DRAM	O	Z	-	-
F2	DA2	DRAM	O	Z	-	-
H3	DA3	DRAM	O	Z	-	-
D2	DA4	DRAM	O	Z	-	-
F1	DA5	DRAM	O	Z	-	-
A1	DA6	DRAM	O	Z	-	-
G4	DA7	DRAM	O	Z	-	-
B1	DA8	DRAM	O	Z	-	-
F4	DA9	DRAM	O	Z	-	-
E2	DA10	DRAM	O	Z	-	-
C2	DA11	DRAM	O	Z	-	-
E1	DA12	DRAM	O	Z	-	-
F3	DA13	DRAM	O	Z	-	-
C1	DA14	DRAM	O	Z	-	-
E3	DA15	DRAM	O	Z	-	-
J3	DBA0	DRAM	O	Z	-	-
K4	DBA1	DRAM	O	Z	-	-
H4	DBA2	DRAM	O	Z	-	-
K3	DWE	DRAM	O	Z	-	-
M3	DCAS	DRAM	O	Z	-	-
L4	DRAS	DRAM	O	Z	-	-
N3	DCS	DRAM	O	Z	-	-
N5	DCS1	DRAM	O	Z	-	-
L3	DODT	DRAM	O	Z	-	-
L7	DODT1	DRAM	O	Z	-	-
R3	DZQ	DRAM	A	Z	-	-
G3	DRST	DRAM	O	Z	-	-
P3	VDD-DLL	POWER	P	-	-	-
H5,J5,K5,L5, H6,J6	VCC-DRAM	POWER	P	-	-	-
GPIO B						
G17	PB0	GPIO	I/O	Z	NO PULL	20
G16	PB1	GPIO	I/O	Z	NO PULL	20
F17	PB2	GPIO	I/O	Z	NO PULL	20
F16	PB3	GPIO	I/O	Z	NO PULL	20
G14	PB4	GPIO	I/O	Z	NO PULL	20
G15	PB5	GPIO	I/O	Z	NO PULL	20
F14	PB6	GPIO	I/O	Z	NO PULL	20
F15	PB7	GPIO	I/O	Z	NO PULL	20
GPIO C						
D12	PC0	GPIO	I/O	Z	NO PULL	20
C12	PC1	GPIO	I/O	Z	NO PULL	20
C11	PC2	GPIO	I/O	Z	NO PULL	20
D11	PC3	GPIO	I/O	Z	PULL UP	20
B11	PC4	GPIO	I/O	Z	PULL UP	20

BALL#	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
C10	PC5	GPIO	I/O	Z	NO PULL	20
D10	PC6	GPIO	I/O	Z	PULL UP	20
A12	PC7	GPIO	I/O	Z	NO PULL	20
A11	PC8	GPIO	I/O	Z	NO PULL	20
B10	PC9	GPIO	I/O	Z	NO PULL	20
A10	PC10	GPIO	I/O	Z	NO PULL	20
B9	PC11	GPIO	I/O	Z	NO PULL	20
A9	PC12	GPIO	I/O	Z	NO PULL	20
B8	PC13	GPIO	I/O	Z	NO PULL	20
A8	PC14	GPIO	I/O	Z	NO PULL	20
B7	PC15	GPIO	I/O	Z	NO PULL	20
A7	PC16	GPIO	I/O	Z	NO PULL	20
GPIO D						
R12	PD2	GPIO	I/O	Z	NO PULL	20
P12	PD3	GPIO	I/O	Z	NO PULL	20
R11	PD4	GPIO	I/O	Z	NO PULL	20
P11	PD5	GPIO	I/O	Z	NO PULL	20
R10	PD6	GPIO	I/O	Z	NO PULL	20
P10	PD7	GPIO	I/O	Z	NO PULL	20
R9	PD10	GPIO	I/O	Z	NO PULL	20
P9	PD11	GPIO	I/O	Z	NO PULL	20
R8	PD12	GPIO	I/O	Z	NO PULL	20
P8	PD13	GPIO	I/O	Z	NO PULL	20
R7	PD14	GPIO	I/O	Z	NO PULL	20
P7	PD15	GPIO	I/O	Z	NO PULL	20
U11	PD18	GPIO	I/O	Z	NO PULL	20
T11	PD19	GPIO	I/O	Z	NO PULL	20
U10	PD20	GPIO	I/O	Z	NO PULL	20
T10	PD21	GPIO	I/O	Z	NO PULL	20
U9	PD22	GPIO	I/O	Z	NO PULL	20
T9	PD23	GPIO	I/O	Z	NO PULL	20
U8	PD24	GPIO	I/O	Z	NO PULL	20
T8	PD25	GPIO	I/O	Z	NO PULL	20
U7	PD26	GPIO	I/O	Z	NO PULL	20
T7	PD27	GPIO	I/O	Z	NO PULL	20
M11,N11	VCC-PD	POWER	P	-	-	-
GPIO E						
C5	PE0	GPIO	I/O	Z	NO PULL	20
D5	PE1	GPIO	I/O	Z	NO PULL	20
C6	PE2	GPIO	I/O	Z	NO PULL	20
D6	PE3	GPIO	I/O	Z	NO PULL	20
A6	PE4	GPIO	I/O	Z	NO PULL	20
B6	PE5	GPIO	I/O	Z	NO PULL	20
A5	PE6	GPIO	I/O	Z	NO PULL	20
B5	PE7	GPIO	I/O	Z	NO PULL	20
A4	PE8	GPIO	I/O	Z	NO PULL	20
B4	PE9	GPIO	I/O	Z	NO PULL	20
A3	PE10	GPIO	I/O	Z	NO PULL	20
B3	PE11	GPIO	I/O	Z	NO PULL	20
A2	PE12	GPIO	I/O	Z	NO PULL	20

BALL#	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
B2	PE13	GPIO	I/O	Z	NO PULL	20
C3	PE14	GPIO	I/O	Z	NO PULL	20
D3	PE15	GPIO	I/O	Z	NO PULL	20
C4	PE16	GPIO	I/O	Z	NO PULL	20
D4	PE17	GPIO	I/O	Z	NO PULL	20
GPIO F						
D9	PF0	GPIO	I/O	F	NO PULL	20
C9	PF1	GPIO	I/O	F	NO PULL	20
D8	PF2	GPIO	I/O	Z	NO PULL	20
C8	PF3	GPIO	I/O	F	NO PULL	20
D7	PF4	GPIO	I/O	Z	NO PULL	20
C7	PF5	GPIO	I/O	F	NO PULL	20
GPIO G						
A15	PG0	GPIO	I/O	Z	NO PULL	20
B15	PG1	GPIO	I/O	Z	NO PULL	20
A14	PG2	GPIO	I/O	Z	NO PULL	20
B14	PG3	GPIO	I/O	Z	NO PULL	20
A13	PG4	GPIO	I/O	Z	NO PULL	20
B13	PG5	GPIO	I/O	Z	NO PULL	20
A17	PG6	GPIO	I/O	Z	NO PULL	20
B17	PG7	GPIO	I/O	Z	NO PULL	20
A16	PG9	GPIO	I/O	Z	NO PULL	20
B16	PG8	GPIO	I/O	Z	NO PULL	20
C17	PG10	GPIO	I/O	Z	NO PULL	20
C16	PG11	GPIO	I/O	Z	NO PULL	20
C15	PG12	GPIO	I/O	Z	NO PULL	20
C14	PG13	GPIO	I/O	Z	NO PULL	20
GPIO H						
D17	PH0	GPIO	I/O	Z	NO PULL	20
D16	PH1	GPIO	I/O	Z	NO PULL	20
D15	PH2	GPIO	I/O	Z	NO PULL	20
D14	PH3	GPIO	I/O	Z	NO PULL	20
D13	PH4	GPIO	I/O	Z	NO PULL	20
C13	PH5	GPIO	I/O	Z	NO PULL	20
E17	PH6	GPIO	I/O	Z	NO PULL	20
E16	PH7	GPIO	I/O	Z	NO PULL	20
E15	PH8	GPIO	I/O	Z	NO PULL	20
E14	PH9	GPIO	I/O	Z	NO PULL	20
GPIO L						
P16	PL0	GPIO	I/O	Z	PULL UP	20
P15	PL1	GPIO	I/O	Z	PULL UP	20
U14	PL2	GPIO	I/O	Z	NO PULL	20
T14	PL3	GPIO	I/O	Z	NO PULL	20
R14	PL4	GPIO	I/O	Z	NO PULL	20
P14	PL5	GPIO	I/O	Z	NO PULL	20
U13	PL6	GPIO	I/O	Z	NO PULL	20
T13	PL7	GPIO	I/O	Z	NO PULL	20
R13	PL8	GPIO	I/O	Z	NO PULL	20
P13	PL9	GPIO	I/O	Z	NO PULL	20
U12	PL10	GPIO	I/O	Z	NO PULL	20
T12	PL11	GPIO	I/O	Z	NO PULL	20

BALL#	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
SYSTEM CONTROL						
N14	NMI	-	I	Z	NO PULL	-
P17	RESET	-	I	Z	NO PULL	-
USB						
T16	USB-DM0	-	A	-	-	-
T17	USB-DP0	-	A	-	-	-
U16	USB-DM1	-	A	-	-	-
U17	USB-DP1	-	A	-	-	-
L12	VCC-USB	-	P	-	-	-
HSIC						
N12	VCC-HSIC	-	P	-	-	-
T15	HSIC-STR	-	A	-	-	-
U15	HSIC-DAT	-	A	-	-	-
AUDIO CODEC						
M16	MIC1N	-	A	-	-	-
M17	MIC1P	-	A	-	-	-
N16	MIC2N	-	A	-	-	-
N17	MIC2P	-	A	-	-	-
J15	LINEINR	-	A	-	-	-
H15	LINEINL	-	A	-	-	-
K16	VRA1	-	A	-	-	-
K17	VRA2	-	A	-	-	-
L16	AVCC	-	P	-	-	-
L17	VRP	-	A	-	-	-
N15	PHONEOUTN	-	A	-	-	-
M15	PHONEOUTP	-	A	-	-	-
K15	PHONEINN	-	A	-	-	-
L15	PHONEINP	-	A	-	-	-
J14	HBIAS	-	A	-	-	-
K14	MBIAS	-	A	-	-	-
H13	AGND	-	G	-	-	-
J16	HPOUTR	-	A	-	-	-
J17	HPOUTL	-	A	-	-	-
H14	HPCOM	-	A	-	-	-
H16	HPCOMFB	-	A	-	-	-
H17	HPVCCBP	-	P	-	-	-
K13	HPVCCIN	-	P	-	-	-
LRADC						
L14	LRADC0	-	A	-	-	-
DSI						
R4	DSI-D0N	-	A	-	-	-
P4	DSI-D0P	-	A	-	-	-
R5	DSI-D1N	-	A	-	-	-
P5	DSI-D1P	-	A	-	-	-
U6	DSI-D2N	-	A	-	-	-
T6	DSI-D2P	-	A	-	-	-
R6	DSI-D3N	-	A	-	-	-
P6	DSI-D3P	-	A	-	-	-
U5	DSI-CKN	-	A	-	-	-
T5	DSI-CKP	-	A	-	-	-
N6	VCC-DSI	-	P	-	-	-

BALL#	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
CLOCK						
R17	X32KIN	-	A	-	-	-
R16	X32KOUT	-	A	-	-	-
R15	X32KFOUT	-	A	-	-	-
M13	RTCVIO	-	P	-	-	-
M12	VCC-RTC	-	P	-	-	-
U4	X24MIN	-	A	-	-	-
T4	X24MOUT	-	A	-	-	-
M5	VCC-PLL	-	P	-	-	-
POWER						
M8	VCC-EFUSE	-	P	-	-	-
M14	VDD-CPUS	-	P	-	-	-
E5,E6,E7,F5,F6, F7,G5,G6	VDD-CPU	-	P	-	-	-
E8,E9,E10,K6, L6,M6,M7,N8 N9,N10	VDD-SYS	-	P	-	-	-
E11,E12,F11 F12,G12	VCC-IO	-	P	-	-	-
N4,F8,F9,F10, G7,G8,G9,G10, G11,H7,H8, H9,H10,H11, H12,J7,J8,J9, J10,J11,J12 K7,K8,K9,K10, K11,K12, L8,L9,L10, L11,M9,M10	GND	-	G	-	-	-

4.2. GPIO MULTIPLEXING FUNCTIONS

Following table provides a description of the GPIO multiplexing functions of A33.

Port	Default Function	IO Type	Default IO State	Default Pull Up/Down	Multiplexed Function 2	Multiplexed Function 3	Multiplexed Function 4
PB0	GPIO	I/O	DIS	Z	UART2-TX	UART0-TX	PB-EINT0
PB1	GPIO	I/O	DIS	Z	UART2-RX	UART0-RX	PB-EINT1
PB2	GPIO	I/O	DIS	Z	UART2-RTS	-	PB-EINT2
PB3	GPIO	I/O	DIS	Z	UART2-CTS	-	PB-EINT3
PB4	GPIO	I/O	DIS	Z	PCM0-SYNC	AIF2-SYNC	PB-EINT4
PB5	GPIO	I/O	DIS	Z	PCM0-BCLK	AIF2-BCLK	PB-EINT5
PB6	GPIO	I/O	DIS	Z	PCM0-DOUT	AIF2-DOUT	PB-EINT6
PB7	GPIO	I/O	DIS	Z	PCM0-DIN	AIF2-DIN	PB-EINT7
PC0	GPIO	I/O	DIS	Z	NAND-WE	SPI0-MOSI	-
PC1	GPIO	I/O	DIS	Z	NAND-ALE	SPI0-MISO	-
PC2	GPIO	I/O	DIS	Z	NAND-CLE	SPI0-CLK	-
PC3	GPIO	I/O	DIS	Pull-up	NAND-CE1	SPI0-CS	-
PC4	GPIO	I/O	DIS	Pull-up	NAND-CE0	-	-
PC5	GPIO	I/O	DIS	Z	NAND-RE	SDC2-CLK	-
PC6	GPIO	I/O	DIS	Pull-up	NAND-RB0	SDC2-CMD	-
PC7	GPIO	I/O	DIS	Pull-up	NAND-RB1	-	-
PC8	GPIO	I/O	DIS	Z	NAND-DQ0	SDC2-D0	-
PC9	GPIO	I/O	DIS	Z	NAND-DQ1	SDC2-D1	-
PC10	GPIO	I/O	DIS	Z	NAND-DQ2	SDC2-D2	-
PC11	GPIO	I/O	DIS	Z	NAND-DQ3	SDC2-D3	-
PC12	GPIO	I/O	DIS	Z	NAND-DQ4	SDC2-D4	-
PC13	GPIO	I/O	DIS	Z	NAND-DQ5	SDC2-D5	-
PC14	GPIO	I/O	DIS	Z	NAND-DQ6	SDC2-D6	-
PC15	GPIO	I/O	DIS	Z	NAND-DQ7	SDC2-D7	-
PC16	GPIO	I/O	DIS	Z	NAND-DQS	SDC2-RST	-
PD2	GPIO	I/O	DIS	Z	LCD-D2	SDC1-CLK	-
PD3	GPIO	I/O	DIS	Z	LCD-D3	SDC1-CMD	-
PD4	GPIO	I/O	DIS	Z	LCD-D4	SDC1-D0	-
PD5	GPIO	I/O	DIS	Z	LCD-D5	SDC1-D1	-
PD6	GPIO	I/O	DIS	Z	LCD-D6	SDC1-D2	-
PD7	GPIO	I/O	DIS	Z	LCD-D7	SDC1-D3	-
PD10	GPIO	I/O	DIS	Z	LCD-D10	UART1-TX	-
PD11	GPIO	I/O	DIS	Z	LCD-D11	UART1-RX	-
PD12	GPIO	I/O	DIS	Z	LCD-D12	UART1-RTS	-
PD13	GPIO	I/O	DIS	Z	LCD-D13	UART1-CTS	-
PD14	GPIO	I/O	DIS	Z	LCD-D14		-
PD15	GPIO	I/O	DIS	Z	LCD-D15		-
PD18	GPIO	I/O	DIS	Z	LCD-D18	LVDS-VP0	-
PD19	GPIO	I/O	DIS	Z	LCD-D19	LVDS-VN0	-
PD20	GPIO	I/O	DIS	Z	LCD-D20	LVDS-VP1	-
PD21	GPIO	I/O	DIS	Z	LCD-D21	LVDS-VN1	-
PD22	GPIO	I/O	DIS	Z	LCD-D22	LVDS-VP2	-
PD23	GPIO	I/O	DIS	Z	LCD-D23	LVDS-VN2	-
PD24	GPIO	I/O	DIS	Z	LCD-CLK	LVDS-VPC	-
PD25	GPIO	I/O	DIS	Z	LCD-DE	LVDS-VNC	-

PD26	GPIO	I/O	DIS	Z	LCD-HSYNC	LVDS-VP3	-
PD27	GPIO	I/O	DIS	Z	LCD-VSYNC	LVDS-VN3	-
PE0	GPIO	I/O	DIS	Z	CSI-PCLK	-	-
PE1	GPIO	I/O	DIS	Z	CSI-MCLK	-	-
PE2	GPIO	I/O	DIS	Z	CSI-HSYNC	-	-
PE3	GPIO	I/O	DIS	Z	CSI-VSYNC	-	-
PE4	GPIO	I/O	DIS	Z	CSI-D0	-	-
PE5	GPIO	I/O	DIS	Z	CSI-D1	-	-
PE6	GPIO	I/O	DIS	Z	CSI-D2	-	-
PE7	GPIO	I/O	DIS	Z	CSI-D3	-	-
PE8	GPIO	I/O	DIS	Z	CSI-D4	-	-
PE9	GPIO	I/O	DIS	Z	CSI-D5	-	-
PE10	GPIO	I/O	DIS	Z	CSI-D6	-	-
PE11	GPIO	I/O	DIS	Z	CSI-D7	-	-
PE12	GPIO	I/O	DIS	Z	CSI-SCK	TWI2-SCK	-
PE13	GPIO	I/O	DIS	Z	CSI-SDA	TWI2-SDA	-
PE14	GPIO	I/O	DIS	Z	-	-	-
PE15	GPIO	I/O	DIS	Z	-	-	-
PE16	GPIO	I/O	DIS	Z	-	-	-
PE17	GPIO	I/O	DIS	Z	-	-	-
PF0	GPIO	I/O	JTAG	F	SDC0-D1	JTAG-MS1	-
PF1	GPIO	I/O	JTAG	F	SDC0-D0	JTAG-DI1	-
PF2	GPIO	I/O	DIS	Z	SDC0-CLK	UART0-TX	-
PF3	GPIO	I/O	JTAG	F	SDC0-CMD	JTAG-DO1	-
PF4	GPIO	I/O	DIS	Z	SDC0-D3	UART0-RX	-
PF5	GPIO	I/O	JTAG	F	SDC0-D2	JTAG-CK1	-
PG0	GPIO	I/O	DIS	Z	SDC1-CLK	-	PG-EINT0
PG1	GPIO	I/O	DIS	Z	SDC1-CMD	-	PG-EINT1
PG2	GPIO	I/O	DIS	Z	SDC1-D0	-	PG-EINT2
PG3	GPIO	I/O	DIS	Z	SDC1-D1	-	PG-EINT3
PG4	GPIO	I/O	DIS	Z	SDC1-D2	-	PG-EINT4
PG5	GPIO	I/O	DIS	Z	SDC1-D3	-	PG-EINT5
PG6	GPIO	I/O	DIS	Z	UART1-TX	-	PG-EINT6
PG7	GPIO	I/O	DIS	Z	UART1-RX	-	PG-EINT7
PG8	GPIO	I/O	DIS	Z	URAT1-RTS	-	PG-EINT8
PG9	GPIO	I/O	DIS	Z	UART1-CTS	-	PG-EINT9
PG10	GPIO	I/O	DIS	Z	PCM1-SYNC	AIF3-SYNC	PG-EINT10
PG11	GPIO	I/O	DIS	Z	PCM1-BCLK	AIF3-BCLK	PG-EINT11
PG12	GPIO	I/O	DIS	Z	PCM1-DOUT	AIF3-DOUT	PG-EINT12
PG13	GPIO	I/O	DIS	Z	PCM1-DIN	AIF3-DIN	PG-EINT13
PH0	GPIO	I/O	DIS	Z	PWM0	-	-
PH1	GPIO	I/O	DIS	Z	PWM1	-	-
PH2	GPIO	I/O	DIS	Z	TWI0-SCK	-	-
PH3	GPIO	I/O	DIS	Z	TWI0-SDA	-	-
PH4	GPIO	I/O	DIS	Z	TWI1-SCK	-	-
PH5	GPIO	I/O	DIS	Z	TWI1-SDA	-	-
PH6	GPIO	I/O	DIS	Z	SPI0-CS	UART3-TX	-
PH7	GPIO	I/O	DIS	Z	SPI0-CLK	UART3-RX	-
PH8	GPIO	I/O	DIS	Z	SPI0-MOSI	UART3-RTS	-
PH9	GPIO	I/O	DIS	Z	SPI0-MISO	UART3-CTS	-
PL0	GPIO	I/O	DIS	Pull-up	S-RSB-SCK	S-TWI-SCK	S-PL-EINT0
PL1	GPIO	I/O	DIS	Pull-up	S-RSB-SDA	S-TWI-SDA	S-PL-EINT1
PL2	GPIO	I/O	DIS	Z	S-UART-TX	-	S-PL-EINT2
PL3	GPIO	I/O	DIS	Z	S-UART-RX	-	S-PL-EINT3
PL4	GPIO	I/O	DIS	Z	S-JTAG-MS	-	S-PL-EINT4

PL5	GPIO	I/O	DIS	Z	S-JTAG-CK	-	S-PL-EINT5
PL6	GPIO	I/O	DIS	Z	S-JTAG-DO	-	S-PL-EINT6
PL7	GPIO	I/O	DIS	Z	S-JTAG-DI	-	S-PL-EINT7
PL8	GPIO	I/O	DIS	Z	S-TWI-SCK	-	S-PL-EINT8
PL9	GPIO	I/O	DIS	Z	S-TWI-SDA	-	S-PL-EINT9
PL10	GPIO	I/O	DIS	Z	S-PWM	-	S-PL-EINT10
PL11	GPIO	I/O	DIS	Z	-	-	S-PL-EINT11

4.3. DETAILED PIN/SIGNAL DESCRIPTION

Pin/Signal	Description	Type
DRAM		
DQ[15:0]	DRAM DQ[15:0]	I/O
DVREF	DRAM Reference Input	P
DQS[1:0]	DRAM Data Strobe DQS[1:0]	I/O
DQSB[1:0]	DRAM Data Strobe DQSB[1:0]	I/O
DCK	DRAM Clock	O
DCKB	DRAM CKB	O
DCKE[1:0]	DRAM Clock Enable [1:0]	O
DA[15:0]	DRAM Data Address[15:0]	O
DBA[2:0]	DRAM Bank Address[2:0]	O
DWE	DRAM Write Enable	O
DCAS	DRAM Column Address Strobe	O
DRAS	DRAM Row Address Strobe	O
DCS[1:0]	DRAM Chip Select[1:0]	O
DODT[1:0]	DRAM ODT Control [1:0]	O
DZQ	DRAM ZQ Calibration	A
DRST	DRAM Reset	O
VDD-DLL	DLL Power Supply	P
VCC-DRAM	DRAM Power Supply	P
GPIO		
PB[7:0]	Port B Bit[7:0]	I/O
PC[18:0]	Port C Bit[18:0]	I/O
PD[27:0]	Port D Bit[27:0]	I/O
VCC-PD	Port D Power Supply	P
PE[17:0]	Port E Bit[17:0]	I/O
PF[5:0]	Port F Bit[5:0]	I/O
PG[13:0]	Port G Bit[13:0]	I/O
PH[9:0]	Port H Bit[9:0]	I/O
PL[11:0]	Port L Bit[11:0]	I/O
SYSTEM CONTROL		
NMI	Non-Maskable Interrupt	I
RESET	Reset Signal	I
INTERRUPT		
EINT	External Interrupt	I
PWM		
PWM[1:0]	PWM	O
CLOCK		
X32KIN	Clock Input of 32768Hz Crystal	A

Pin/Signal	Description	Type
X32KOUT	Clock Output of 32768Hz Crystal	A
X32KFOUT	Clock Output of LOSC (X32KFOUT can be gating)	OD
RTCVIO	RTC Power	P
VCC-RTC	RTC Power Supply	P
X24MIN	Clock Input of 24MHz Crystal	A
X24MOUT	Clock Output of 24MHz Crystal	A
VCC-PLL	PLL Power	P
NAND FLASH		
NAND-DQ[7:0]	NAND Flash Data Bit[7:0]	I/O
NAND-CE[1:0]	NAND Flash Chip Select[1:0]	O
NAND-WE	NAND Flash Write Enable	O
NAND-ALE	NAND Flash Address Latch Enable	O
NAND-CLE	NAND Flash Command Latch Enable	O
NAND-RE	NAND Flash Read Enable	O
NAND-RB	NAND Flash Ready/Busy Bit	I
NAND-DQS	NAND Flash Data Strobe	I/O
LCD		
LCD-D[23:0]	LCD Data Bit[23:0]	O
LCD-CLK	LCD Clock Signal	O
LCD-DE	LCD Data Enable	O
LCD-HSYNC	LCD Horizontal SYNC	O
LCD-VSYNC	LCD Vertical SYNC	O
LVDS		
LVDS-VP[3:0]	LVDS Data Positive Signal Output[3:0]	A
LVDS-VN[3:0]	LVDS Data Negative Signal Output[3:0]	A
LVDS-VPC	LVDS Clock Positive Output	A
LVDS-VNC	LVDS Clock Negative Output	A
DSI		
DSI-DN(3:0)	DSI Data Negative	A
DSI-DP(3:0)	DSI Data Positive	A
DSI-CKN	DSI Clock Negative	A
DSI-CKP	DSI Clock Positive	A
VCC-DSI	DSI Power Supply	P
CSI		
CSI-D[7:0]	CSI0 Data Bit[7:0]	I
CSI-PCLK	CSI Pixel Clock	I
CSI-MCLK	CSI Master Clock	O
CSI-SCK	CSI Clock Signal	IO
CSI-SDA	CSI Data Signal	IO
CSI-HSYNC	CSI Horizontal SYNC	I
CSI-VSYNC	CSI Vertical SYNC	I
USB		
USB-DM[1:0]	USB DM[1:0] Signal	A
USB-DP[1:0]	USB DP[1:0] Signal	A
VCC-USB	USB Power Supply	P
HSIC		
VCC-HSIC	HSIC Power Supply	P
HSIC-STR	USB HSIC Strobe signal	A
HSIC-DAT	USB HSIC Data signal	A
AUDIO CODEC		
PHONEOUTN	Phone Negative Output	A
PHONEOUTP	Phone Positive Output	A
PHONEINN	Phone Negative Input	A

Pin/Signal	Description	Type
PHONEINP	Phone Positive Input	A
MICINN[2:1]	MIC Negative Input	A
MICINP[2:1]	MIC Positive Input	A
LINEINR	Line-in Right Input	A
LINEINL	Line-in Left Input	A
HBIAS	HBIAS	A
MBIAS	MBIAS	A
VRA1	Reference Voltage	A
VRA2	Reference Voltage	A
AVCC	Analog Power Supply	P
VRP	Reference Voltage	A
AGND	Analog Ground	G
HPOUTR	Headphone Right Channel Output	A
HPOUTL	Headphone Left Channel Output	A
HPVCCIN	Headphone VCC Input	A
HPVCCBP	Headphone VCC Bypass	A
HPCOM	Headphone Common Reference	A
HPCOMFB	Headphone Common Reference Feedback	A
HPBP	Headphone Bypass Output	A
AIF-SYNC	Audio Codec SYNC Signal	A
AIF-BCLK	Audio Codec Clock Signal	A
AIF-DOUT	Audio Codec Data Output	A
AIF-DIN	Audio Codec Data Input	A
LRADC		
LRADC0	LRADC Input	A
SPI		
SPI0-CS	SPI Chip Select Signal	I/O
SPI0-CLK	SPI Clock Signal	I/O
SPI0-MOSI	SPI Master Data Out, Slave Data In	I/O
SPI0-MISO	SPI Master Data In, Slave Data Out	I/O
UART (x=[3:0])		
UARTx-TX	UART Data Transmit	O
UARTx-RX	UART Data Receive	I
UARTx-RTS	UART Data Request to Send	O
UARTx-CTS	UART Data Clear to Send	I
TWI (x=[2:0])(Open-Drain)		
TWIx-SCK	TWI Clock Signal	I/O
TWIx-SDA	TWI Data Signal	I/O
SD/MMC (x=[2:0])		
SDCx-D	SD/MMC/SDIO Data Bit	I/O
SDCx-CLK	SD/MMC/SDIO Clock	O
SDCx-CMD	SD/MMC/SDIO Command Signal	I/O
SDC-RST	SD/MMC/SDIO Reset Signal	O
PCM (x=[1:0])		
PCMx-SYNC	PCM SYNC	I/O
PCMx-CLK	PCM Clock	I/O
PCMx-DOUT	PCM Data Output	O
PCMx-DIN	PCM Data Input	I
RSB		
S-RSB-SCK	RSB Clock	O
S-RSB-SDA	RSB Data	I/O

Pin/Signal	Description	Type
POWER		
VDD-CPU	CPU Power Supply	P
VDD-CPUS	CPUS Power Supply	P
VDD-SYS	System Power Supply	P
VCC-EFUSE	EFUSE Power Supply	p
GND	Ground	G
VCC-IO	IO Power Supply	P

5

ELECTRICAL CHARACTERISTICS

5.1. ABSOLUTE MAXIMUM RATINGS

Functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

SYMBOL	PARAMETER	MIN	MAX	UNIT
T _{STG}	Storage Temperature	-40	125	°C
I _{I/O}	In/Out current for input and output	-40	40	mA
V _{ESD}	ESD stress voltage	-4000	+4000	V _{ESD}
VCC-IO	DC Supply Voltage for I/O	-0.3	3.6	V
VDD-DLL	Power Supply for DLL	-0.3	2.75	V
VCC-DRAM	Power Supply for DRAM	-0.3	1.65	V
VCC-PLL	Power Supply for PLL	-0.3	3.6	V
VCC-RTC	Power Supply for RTC	-0.3	3.6	V
AVCC	DC Supply Voltage for Analog Part	-0.3	3.6	V
VCC-USB	Power Supply for USB PHY	-0.3	3.6	V
VCC-DSI	Power Supply for DSI	-0.3	3.6	V
VDD-CPU	Power Supply for CPU	-0.3	1.5	V
VDD-SYS	Power Supply for System	-0.3	1.5	V

5.2. RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
T _a	Ambient Operating Temperature[Commercial]	-20	-	75	°C
	Operating Temperature[Extended]	-	-	-	°C
VCC-IO	DC Supply Voltage for I/O	1.7	1.8~3.3	3.6	V

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
VDD-DLL	Power Supply for DLL	2.35	2.5	2.65	V
VCC-DRAM	Power Supply for DRAM (DDR3L)	1.283	1.35	1.575	V
	Power Supply for DRAM (DDR3)	1.425	1.5	1.575	V
VCC-PLL	Power Supply for PLL	2.7	3.0	3.3	V
VCC-USB	Power Supply for USB PHY	3.0	3.3	3.45	V
VCC-RTC	Power Supply for RTC	2.7	3.0	3.3	V
AVCC	DC Supply Voltage for Analog Part	2.7	3.0	3.3	V
VCC-DSI	Power Supply for MIPI DSI	2.7	3.3	3.6	V
VDD-CPU	Power Supply for CPU	0.9	1.1	1.4	V
VDD-SYS	Power Supply for System	0.9	1.1	1.4	V

5.3. DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{IH}	High-Level Input Voltage	VCC-IO=3.0V	0.7 x VCC-IO	-	VCC-IO + 0.3	V
V _{IL}	Low-Level Input Voltage	VCC-IO=3.0V	-0.3	-	0.3 x VCC-IO	V
R _{PU}	Input pull-up resistance	VCC-IO=3.0V	50	100	150	K
R _{PD}	Input pull-down resistance	VCC-IO=3.0V	50	100	150	K
V _{HYS}	Hysteresis Voltage	-	0.1 x VCC-IO	-	-	V
I _{IH}	High-Level Input Current	VCC-IO=3.0V, V _I =3.0V	-10	-	10	uA
I _{IL}	Low-Level Input Current	VCC-IO=3.0V, V _I =0V	-10	-	10	uA
V _{OH}	High-Level Output Voltage	VCC-IO=3.0V	VCC-IO - 0.2	-	-	V
V _{OL}	Low-Level Output Voltage	VCC-IO=3.0V	-	-	0.2	V
I _{OZ}	Tri-State Output Leakage Current	VCC-IO=3.0V	-10	-	10	uA
C _{IN}	Input Capacitance	-	-	-	5	pF
C _{OUT}	Output Capacitance	-	-	-	5	pF

5.4. OSCILLATOR ELECTRICAL CHARACTERISTICS

The A33 contains two oscillators: a 24MHz oscillator and a 32768Hz oscillator. Each oscillator requires a specific crystal.

The A33 device operation requires following two input clocks:

- The 32768Hz frequency is used for low frequency operation.
- The 24MHz frequency is used to generate the main source clock of the A33 device.

5.4.1. 24MHz OSCILLATOR CHARACTERISTICS

The 24MHz crystal is connected between the HOSCI (amplifier input) and HOSCO (amplifier output).

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
1/(tCPMAIN)	Crystal Oscillator Frequency Range	-	24	-	MHz
t _{ST}	Startup Time	-	-	-	ms
	Frequency Tolerance at 25°C	-50	-	50	ppm
	Oscillation Mode	Fundamental			-
	Maximum Change Over Temperature Range	-50	-	50	ppm
PON	Drive Level	-	-	50	uW
CL	Equivalent Load Capacitance	-	-	-	pF
CL1,CL2	Internal Load Capacitance(CL1=CL2)	-	-	-	pF
RS	Series Resistance(ESR)	-	-	-	Ω
	Duty Cycle	30	50	70	%
CM	Motional Capacitance	-	-	-	pF
C _{SHUT}	Shunt Capacitance	-	-	-	pF
R _{BIAS}	Internal Bias Resistor	-	-	-	MΩ

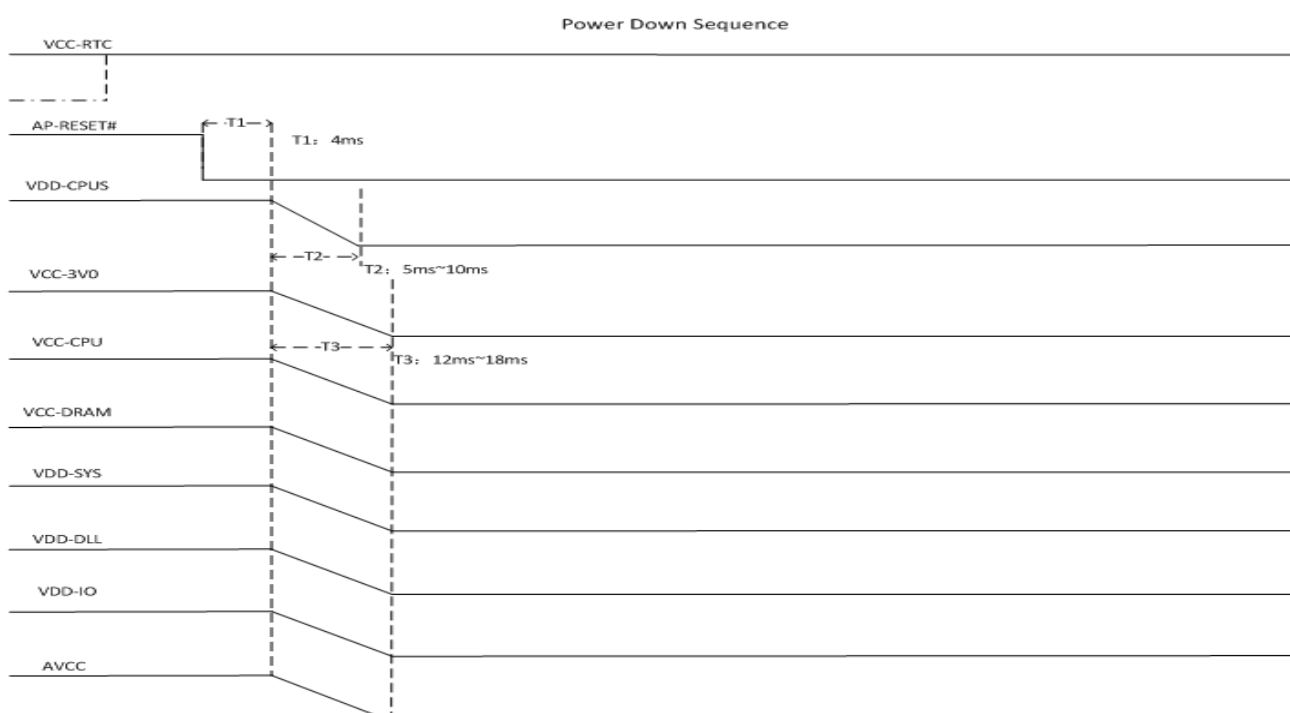
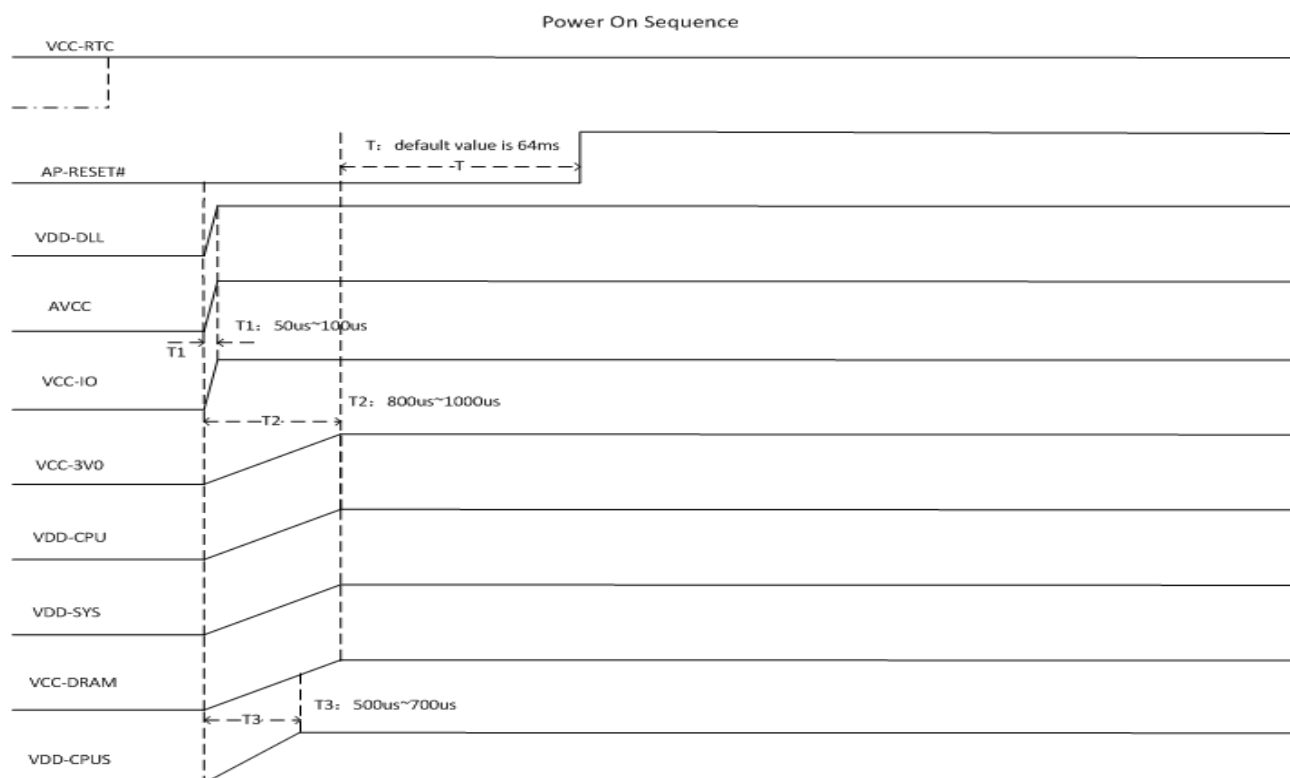
5.4.2. 32768HZ OSCILLATOR CHARACTERISTICS

The 32768Hz crystal is connected between the LOSCI (amplifier input) and LOSCO (amplifier output).

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
1/(tCPMAIN)	Crystal Oscillator Frequency Range	-	32768	-	Hz
t _{ST}	Startup Time	-	-	-	ms
	Frequency Tolerance at 25°C	-50	-	50	ppm
	Oscillation Mode	Fundamental			-
	Maximum Change Over Temperature Range	-50	-	50	ppm
PON	Drive Level	-	-	50	uW
CL	Equivalent Load Capacitance	-	-	-	pF
CL1,CL2	Internal Load Capacitance(CL1=CL2)	-	-	-	pF
RS	Series Resistance(ESR)	-	-	-	Ω
	Duty Cycle	30	50	70	%
CM	Motional Capacitance	-	-	-	pF
C _{SHUT}	Shunt Capacitance	-	-	-	pF
R _{BIAS}	Internal Bias Resistor	-	-	-	MΩ

5.5. POWER UP/DOWN SEQUENCE

The external voltage regulator and other power-on devices must provide the processor with a specific sequence of power and resets to ensure proper operations.

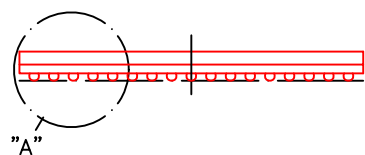


6

PIN ASSIGNMENT

6.1. PIN MAP

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	
A	DA6	PE12	PE10	PE8	PE6	PE4	PC16	PC14	PC12	PC10	PC8	PC7	PG4	PG2	PG0	PG9	PG6	A
B	DA8	PE13	PE11	PE9	PE7	PE5	PC15	PC13	PC11	PC9	PC4		PG5	PG3	PG1	PG8	PG7	B
C	DA14	DA11	PE14	PE16	PE0	PE2	PF5	PF3	PF1	PC5	PC2	PC1	PH5	PG13	PG12	PG11	PG10	C
D	DA1	DA4	PE15	PE17	PE1	PE3	PF4	PF2	PF0	PC6	PC3	PC0	PH4	PH3	PH2	PH1	PH0	D
E	DA12	DA10	DA15	DA0	VDD-CPU	VDD-CPU	VDD-CPU	VDD-SYS	VDD-SYS	VDD-SYS	VCC-IO	VCC-IO		PH9	PH8	PH7	PH6	E
F	DA5	DA2	DA13	DA9	VDD-CPU	VDD-CPU	VDD-CPU	GND	GND	GND	VCC-IO	VCC-IO		PB6	PB7	PB3	PB2	F
G	DCK	DCKB	DRST	DA7	VDD-CPU	VDD-CPU	GND	GND	GND	GND	GND	VCC-IO		PB4	PB5	PB1	PB0	G
H	DQ6	DQ7	DA3	DBA2	VCC-DRAM	VCC-DRAM	GND	GND	GND	GND	GND	GND	AGND	HPCOM	LINEINL	HPCOMFB	HPVCCBP	H
J	DQ4	DQ5	DBA0	DCKE	VCC-DRAM	VCC-DRAM	GND	GND	GND	GND	GND	GND		HBIAS	LINEINR	HPOUTR	HPOUTL	J
K	DQS0B	DQS0	DWE	DBA1	VCC-DRAM	VDD-SYS	GND	GND	GND	GND	GND	GND	HPVCCIN	MBIAS	PHONEINN	VRA1	VRA2	K
L	DQ2	DQ3	DODT	DRAS	VCC-DRAM	VDD-SYS	DODT1	GND	GND	GND	GND	VCC-USB		LRADCO	PHONEINP	AVCC	VRP	L
M	DQ0	DQ1	DCAS	DVREF	VCC-PLL	VDD-SYS	VDD-SYS	VCC-EFUSE	GND	GND	VCC-PD	VCC-RTC	RTCVIO	VDD-CPUS	PHONEOUT	MIC1N	MIC1P	M
N	DQ15	DQM0	DCS	GND	DCS1	VCC-DSI	DCKE1	VDD-SYS	VDD-SYS	VDD-SYS	VCC-PD	VCC-HSIC		NMI	PHONEOUT	MIC2N	MIC2P	N
P	DQ13	DQ14	VDD-DLL	DSI-D0P	DSI-D1P	DSI-D3P	PD15	PD13	PD11	PD7	PD5	PD3	PL9	PL5	PL1	PL0	RESET	P
R	DQS1	DQ12	DZQ	DSI-D0N	DSI-D1N	DSI-D3N	PD14	PD12	PD10	PD6	PD4	PD2	PL8	PL4	X32KFOUT	X32KOUT	X32KIN	R
T	DQS1B	DQ11	DQM1	X24MOUT	DSI-CKP	DSI-D2P	PD27	PD25	PD23	PD21	PD19	PL11	PL7	PL3	HSIC-STR	USB-DM0	USB-DP0	T
U	DQ9	DQ10	DQ8	X24MIN	DSI-CKN	DSI-D2N	PD26	PD24	PD22	PD20	PD18	PL10	PL6	PL2	HSIC-DAT	USB-DM1	USB-DP1	U
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	



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